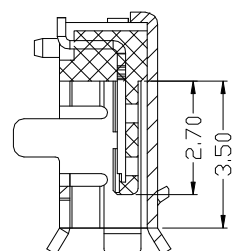
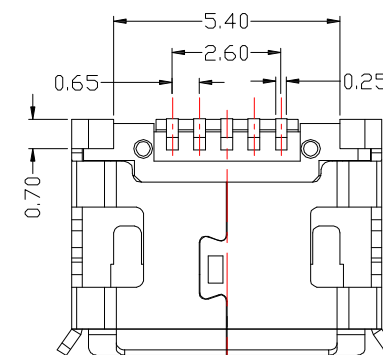
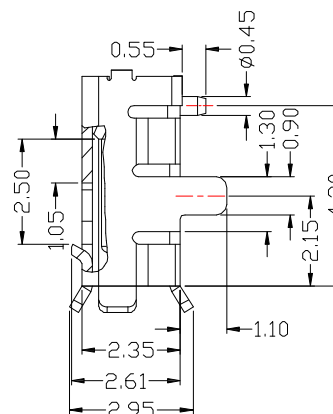
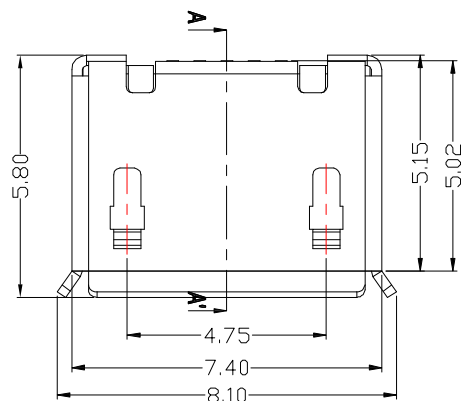


—SHELL鍍層:

TN
NI



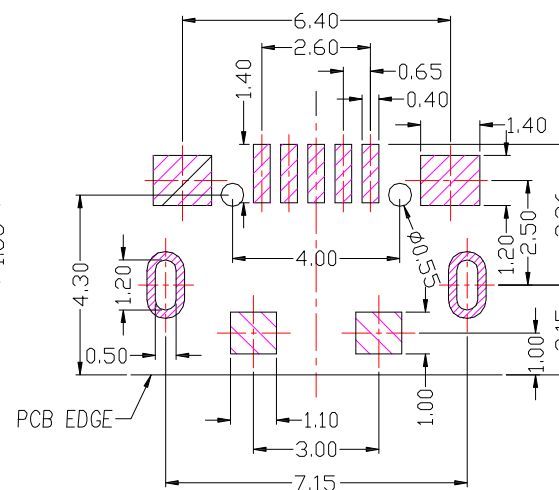
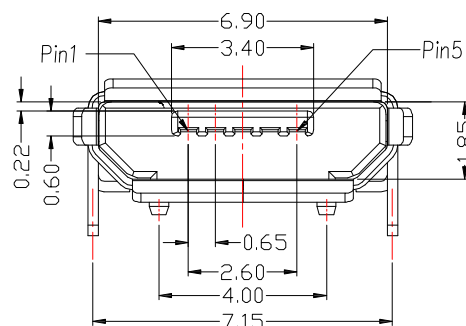
SECTION A-A'



2.1 CONTACT: PLATED GOLD IN MATING AREA ;
GOLD PLATED ON SOLDER BALLS ;
NICKEL UNDER PLATED OVERALL

2.2 SHELL: TIN UNDER PLATED SURFACE LAYER
OR NICKEL UNDER PLATED SURFACE LAYER

3.7 TEMPERATURE RANGE: -30°C ~ +80°C



P.C.B LAYOUT MOUNTING PATTERN

7			
3	更新樣式	Lan	041719
2	更新底部樣式	Jack	012119
1	新增尺寸	Jack	031218
ITEM NO.	DESCRIPTION	DRAWN	DATE



东莞市高迪电子有限公司

Dong Guan KDRR Electronic Switch Jack Co., Ltd.

TOLERANCE UNLESS
OTHERWISE STATED :

Up to 5	± 0.2
Above 5 ~ 15	± 0.3
Above 15 ~ 30	± 0.4
: Above 30 ~ 50	± 0.5
Angle	$\pm 0.3^\circ$

3RD.
ANGEL'S



UNITS

MM

DRAWN BY:	DATE
Jack Lu	04/17/1
CHECKED BY:	DATE
Jacky Chen	04/17/1
APPROVED BY:	DATE
Tony Kao	04/17/1

MAT'L
FINISH
SCALE
SHEET NO

	TITLE	CONNECTOR	
	MODLE	MICRO USB 5B/F SMT 插板7.15 腳長 1.10,有柱 有捲邊	
1 : 1	DWG NO.	MRUSB-5B-ED1x-S347	SIZE A4
1 of 1	PART NO.	MRUSB-5B-ED1x-S347	VER R3